

## Statement of Compliance

## Requested Part

23 September 2025 282888-2 (Part 1 of 1)

TE Internal Number: 282888-2

Product Description: TERMI-BLOK PCB MOUNT 1&2 2P. 5

Part Status: Active

Mil-Spec Certified: No

EU RoHS Directive 2011/65/EU: Compliant with Exemptions

6(c) - Pb-Alloy in Copper

This declaration covers EU Directive 2011/65/EU incl. Delegated Directive 2015/863/EU.

**EU ELV Directive:** Compliant with Exemptions

2000/53/EC 3 - Lead in copper alloy containing up to 4% lead by

weight.

China RoHS 2 Directive: MIIT Order No 32, 2016

有害物质含量超出标准 Restricted Substance(s)

Above Threshold

EU REACH Regulation: Current ECHA Candidate List: JUNE 2025 (250)

(EC) No. 1907/2006 Candidate List Declared Against: JUNE 2025 (250)

SVHC > Threshold:

Pb (2% in 27720376369) Article Safe Usage Statements:

Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable

governmental regulations relevant to your geographic location.

**Halogen Content:** Low Halogen - Br, Cl, F < 900 ppm per homogenous

material. Also BFR/CFR/PVC Free

**Solder Process Capability Code:** Wave solder capable to 265°C

TE Connectivity Corporation 1050 Westlakes Drive Berwyn, PA 19312

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked.

Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV).

Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach



## 23 September 2025



注 2:

## ♠ 有害物质含量超出标准 Restricted Substance(s) Above Threshold

			ŀ				的信息表 ation Table				
部件名称 (Component Name) - 282888-2		有害物质 Hazardous Substance									
		Pb	Hg	Cd	Cr(VI)	PBBs	PBDEs	DBP	DIBP	BBP	DEHP
连接器系统 (Connector Systems)		Х	0	0	0	0	0	0	0	0	0
注 1: O: 表示该有害物质在该部件所有均质材料中的含量均在GB/T 26572标准规定的限量要求以下。 Indicates that the concentration of the hazardous substance in all homogeneous materials of the part is below the relevant threshold of the GB/T 26572 standard.											
In	表示该有害物质至少在该部件的某一均质材料中的含量超出GB/T 26572标准规定的限量要求。 Indicates that the concentration of the hazardous substance in at least one homogeneous material of the part is above the relevant threshold of the GB/T 26572 standard.										

以上未列出的部件,表明其有害物质含量均不超出电器电子产品有害物质限制使用国家标准要求。

The concentration of the hazardous substance in all homogeneous materials of the rest of the part are

注 3: 本表格依据SJ/T 11364标准的规定编制。

below the relevant threshold standard.

- This table is compiled according to SJ/T 11364 standard.
- 电子电气产品的环保使用期限依据SJ/T 11388标准的规定确定。 注 4: The EFUP value of EEP is defined according to SJ/T 11388 standard.